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FILE 'USPAT' ENTERED AT 07:36:42 ON 17 OCT 96
                 WELCOME
                                 ТО
           U, S. PATENT
                                 TEXT
  * * * * * * * * * * * * * * *
=> set step on
SET COMMAND COMPLETED
=> set high on
SET COMMAND COMPLETED
=> s 451/clas
        42159 451/CLAS
=> s teeth (5a) abrasive layer
L2 ( 102009) TEETH
       33279) ABRASIVE
L3 (
L4 ( 454996) LAYER
         352)ABRASIVE LAYER
                 (ABRASIVE(W)LAYER)
             1 TEETH (5A) ABRASIVE LAYER
L6
=> dis 16 cit
1. 5,015,266, May 14, 1991, Abrasive sheet and method for manufacturing
the abrasive sheet; Motokazu Yamamoto, 51/293, 295, 298 [IMAGE AVAILABLE]
=> s cutting wheel (5a) tooth?
       192310) CUTTING
       174852)WHEEL
L8 (
L9 ( 1445) CUTTING WHEEL
                 (CUTTING (W) WHEEL)
        86859) TOOTH?
L10 (
            50 CUTTING WHEEL (5A) TOOTH?
L11
=> s l11 and abrasive layer
L12 ( 33279) ABRASIVE
L13 ( 454996) LAYER
L14 ( 352) ABRASIVE LAYER
                 (ABRASIVE(W)LAYER)
             O L11 AND ABRASIVE LAYER
 L15
 => s l14 and cutting wheel
        33279) ABRASIVE
 L16 (
        454996) LAYER
 L17 (
           352) ABRASIVE LAYER
 L18 (
                  (ABRASIVE (W) LAYER)
 L19 ( 192310) CUTTING
 L20 ( 174852) WHEEL
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L21 (1445) CUTTING WHEEL

(CUTTING (W) WHEEL)

L22 6 L14 AND CUTTING WHEEL

=> dis 122 1-6 cit

- 1. 5,024,026, Jun. 18, 1991, Segmental grinding wheel; William B. Korb, 451/542; 76/37, 45; 451/547 [IMAGE AVAILABLE]
- 2. 4,339,896, Jul. 20, 1982, Abrasive compact dressing tools, tool fabrication methods for dressing a grinding wheel with such tools; Mahlon D. Dennis, et al., 51/298, 297, 307, 308, 309; 125/39 [IMAGE AVAILABLE]
- 3. 4,300,522, Nov. 17, 1981, Compact dressing tool; Robert L. Henry, et al., 125/11.01, 11.03, 39; 407/114 [IMAGE AVAILABLE]
- 4. 4,180,048, Dec. 25, 1979, **Cutting** **wheel**; Barrie F. Regan, 125/15; 451/546 [IMAGE AVAILABLE]
- 5. 3,886,925, Jun. 3, 1975, **Cutting** **wheel**; Barrie F. Regan, 125/15; 451/541 [IMAGE AVAILABLE]
- 6. 3,885,548, May 27, 1975, **Cutting** **wheel** assembly; Barrie F. Regan, 125/15; 206/303; 451/541 [IMAGE AVAILABLE] => dis 122 1-6 ab

US PAT NO: 5,024,026 [IMAGE AVAILABLE]

L22: 1 of 6

ABSTRACT:

Segmental grinding wheel for forming the tip of intersecting surfaces on tools includes an array of peripherally extending and circumferentially, spaced segments. Each segment includes first and second grit-coated angularly oriented grinding surfaces. Another array includes similar grinding segments which are interdigitated in alternating sequence with the segments of the first array. The segments of the two arrays are concentric and partially coextensive in the axial direction of the wheel so that the plane of rotation of the first grinding surface of each segment in one array intersects the plane of rotation of the second grinding surface of an adjacent segment in the other array along a line which represents the tip of the intersecting surfaces.

US PAT NO: 4,339,896 [IMAGE AVAILABLE]

L22: 2 of 6

ABSTRACT:

A method for dressing a grinding wheel, comprising the step of engaging the periphery of a rotating grinding wheel with a dressing tool composed at a positive back rake angle and optionally at a positive side rake angle. The dressing tool is preferably comprised of a composite compact having a first layer of bonded abrasive crystals of diamond or CBN and a second layer of cemented tungsten carbide bonded to the first layer. The compact may be provided with a side cutting edge angle between 0.degree. and 90.degree. and an end edge cutting angle between 0.degree. and 45.degree..

US PAT NO:

4,300,522 [IMAGE AVAILABLE]

L22: 3 of 6

ABSTRACT:

A dresser tool comprises two composite compacts positioned to crush and shear the grinding wheel. Preferably one composite compact is arranged such that its working edge contacts the grinding wheel tangentially; and the other compact is placed so that its working edge is normal to the grinding wheel at a rake angle ranging from positive to negative.

US PAT NO:

4,180,048 [IMAGE AVAILABLE]

L22: 4 of 6

ABSTRACT:

An improved **cutting** **wheel** for dicing semiconductor wafers is described. The cutting blade of the wheel is a thin disc consisting of finely divided abrasive particles embedded in a nickel matrix. The surface of the nickel is overlaid with a thin layer of chromium which is electrolytically deposited on it. The cutting speed and useful life of the wheel are both increased by the presence of the chromium overlay.

US PAT NO:

3,886,925 [IMAGE AVAILABLE]

L22: 5 of 6

ABSTRACT:

An improved **cutting** **wheel** for dicing semi-conductor wafers in which a metal cutting disc with abrasive particles in a nickel matrix is held between a flange and a support ring with a body of elastomeric material compressed therebetween.

US PAT NO: 3,885,548 [IMAGE AVAILABLE]

L22: 6 of 6

ABSTRACT:

A **cutting** **wheel** for dicing semiconductor wafers having a thin cutting disc consisting of abrasive particles in a metal matrix bonded to a flange preformed on a hub and having a diameter larger than that of a flange, the hub having a shoulder extending axially from the flange, a flexible protective washer having a diameter greater than that of the cutting disc is fitted snugly on the hub and in close proximity to the cutting disc.